

Product Bulletin



PRODUCT BULLETIN #:

PB-123438

PUBLICATION DATE:	June 18, 2007
TITLE:	PART MT9040AL/AP - Transitioning From Leaded To Lead-Free Packaging
DESCRIPTION / PURPOSE OF BULLETIN:	In compliance with the Pb-free and RoHS initiatives, Zarlink Semiconductor is transitioning from leaded to lead-free packaging. Details of Zarlink Semiconductor's Pb-Free/RoHS Strategy can be found at: http://quality.zarlink.com/ppp_info/lead_free.htm
MEANS OF DISTINGUISHING THE PRODUCT:	
<input checked="" type="checkbox"/> Product Mark	Leaded MT90840AL ordering part number will be replaced by Pb-free MT90840AL1 ordering part number.
<input type="checkbox"/> Back Mark	Leaded MT90840AP ordering part number will be replaced by Pb-free MT90840AP1 ordering part number.
<input type="checkbox"/> Date Code	Pb-free version is identified by the JEDEC recommended logo marked on the top of each package:
<input type="checkbox"/> Other	 denotes Matte (Pure) Tin Plate. In addition, Pb-free label is added on packing (MBB bag and inner box).
IMPACT:	Please be informed the above product will transition from leaded to a Pb-free package type. After the Transition effective date, leaded product will only be available until inventories are depleted. Once leaded inventory is depleted, only non-leaded product will be available.
DATE EFFECTIVE:	July 3, 2007
ADDITIONAL INFORMATION:	No design changes have been necessary to comply with the RoHS Directive and the fit, form, function and reliability of the parts has not been adversely affected by these changes. All surface mounted Pb-free products are rated MSL 3.
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Note:

The information contained in this Product Bulletin does not affect Form, Fit or Function as specified in the product's Data Sheet at the time of this Product Bulletin release.

